

# B520C - B560C

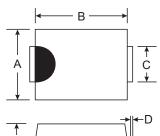
# **5.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER**

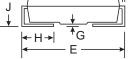
#### **Features**

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automatic Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 175A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Lead Free Finish/RoHS Compliant (Note 3)

## **Mechanical Data**

- Case: SMC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Marking: See Page 2
- Weight: 0.21 grams (approximate)





SMC						
Dim	Min	Max				
Α	5.59	6.22				
В	6.60	7.11				
С	2.75	3.18				
D	0.15	0.31				
Е	7.75	8.13				
G	0.10	0.20				
н	0.76	1.52				
J	2.00	2.62				
All Dimensions in mm						

## Maximum Ratings and Electrical Characteristics @ T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic		Symbol	B520C	B530C	B540C	B550C	B560C	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	30	40	50	60	v
RMS Reverse Voltage		V <sub>R(RMS)</sub>	14	21	28	35	42	V
Average Rectified Output Current	@ $T_T = 90^{\circ}C$	lo	5.0			А		
Non-Repetitive Peak Forward Surge C half-sine-wave Superimposed on Rate		I <sub>FSM</sub>	175			А		
Forward Voltage	@ I <sub>F</sub> = 5.0A DC	V <sub>FM</sub>	0.55 0.70		70	V		
Peak Reverse Current at Rated DC Blocking Voltage	@ $T_A = 25^{\circ}C$ @ $T_A = 100^{\circ}C$	I <sub>RM</sub>	0.5 20			mA		
Typical Total Capacitance (Note 2)		Ст	300				pF	
Thermal Resistance, Junction to Terminal		R <sub>θJT</sub>	10				°C/W	
Thermal Resistance, Junction to Ambient (Note 1)		R <sub>0JA</sub>	50				°C/W	
Operating Temperature Range		Tj	-55 to +125				°C	
Storage Temperature Range		T <sub>STG</sub>	-55 to +150				°C	

Notes: 1. Thermal Resistance: Junction to ambient, unit mounted on PC board with 8.0 mm<sup>2</sup> (0.033 mm thick) copper pads as heat sink.

2. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC.

3. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.

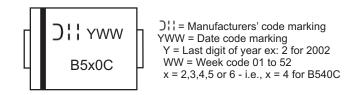


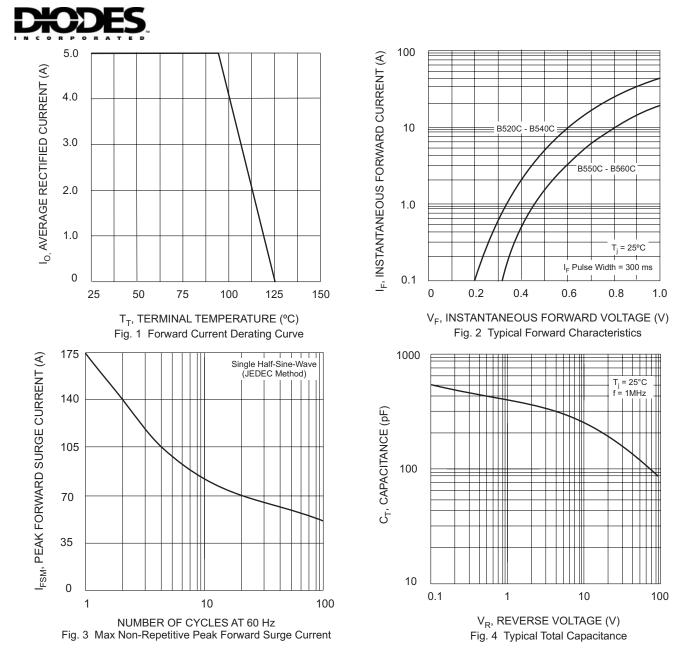
#### Ordering Information (Note 4)

Device	Packaging	Shipping	
B520C-13-F	SMC	3000/Tape & Reel	
B530C-13-F	SMC	3000/Tape & Reel	
B540C-13-F	SMC	3000/Tape & Reel	
B550C-13-F	SMC	3000/Tape & Reel	
B560C-13-F	SMC	3000/Tape & Reel	

Notes: 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## **Marking Information**





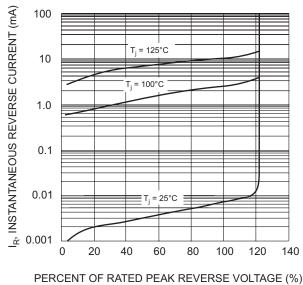


Fig. 5 Typical Reverse Characteristics



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